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ABSTRACT

The purpose of the present invention is to provide a hot plate unit capable of carrying out temperature-rising and 5 temperature-falling sufficiently quickly even if the diameter of a substrate becomes wide and with which apparatus can be downsized. The present invention provides a hot plate unit comprising a supporting case and a substrate equipped with a temperature adjustment means; said substrate being fitted to 10 the supporting case, wherein the thickness of the supporting case is 50 mm or less.